Gallium Nitride 28V 150W, RF Power Transistor

Description

The NU2515H is a 150W 28V, unmatched GaN HEMT, designed for multiple applications with frequencies up to 2.5GHz.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

• Typical performance (on different application fixtures with device soldered)

V_{DD}=28V I_{DQ}=100mA, CW, Vgs=-2.71V

		0			
Freq(MHz)	Pin(dBm)	Psat(dBm)	Psat(W)	Gain(dB)	Eff(%)
1100-1300	35.2	50.9-51.6	123-145	15.7-16.3	71-72
1500-1700	38	50.85-51.68	120-147	12.5-13.4	69-72
1300-1950	40	50.85-51.3	120-130	10.5-11.5	65-69

NU2515H

Applications and Features

- Suitable for wireless communication infrastructure, wideband amplifier, EMC testing, ISM etc.
- High Efficiency and Linear Gain Operations
- Thermally Enhanced Industry Standard Package
- High Reliability Metallization Process
- · Excellent thermal Stability and Excellent Ruggedness
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

- 1. Set VGS to the pinch--off (VP) voltage, typically -5~V
- 2. Turn on VDS to nominal supply voltage (28V)
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Table 1. Maximum Ratings (Not simultaneous, TC = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
DrainSource Voltage	$V_{ t DSS}$	150	Vdc
GateSource Voltage	$V_{\sf GS}$	-10,+2	Vdc
Operating Voltage	V_{DD}	40	Vdc
Maximum Forward Gate Current	Igmax	36	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature(See note 1)	Τ _ν	+225	°C
Total Device Power Dissipation (Derated above 25°C, see note 2)	Pdiss	165	W

- 1. Continuous operation at maximum junction temperature will affect MTTF
- 2. Bias Conditions should also satisfy the following expression: Pdiss < (Tj Tc) / RJC and Tc = Tcase

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Do to Do	1.2	°C /\
T _C = 85°C, T _J =200°C, DC Power Dissipation(See note 1)	Rejc-dc	1.2	°C/W

ReJC-DC is tested at only DC condition, it is related to the highest thermal resistor value among all test conditions. It might be differently lower in different RF operation conditions like CW signal ,pulsed RF signal etc.

Table 3. Electrical Characteristics (T_C = 25 °C unless otherwise noted)

DC Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Orain-Source Breakdown Voltage V _{GS} =-8V; I _{DS} =36mA		V_{DSS}	150			V
Gate Threshold Voltage V _{DS} = 28V, I _D =36mA		V _{GS} (th)	-4	-	-2	V
Gate Quiescent Voltage V _{DS} =28V, I _{DS} =100mA, Measured in Functional Test		V _{GS(Q)}		-2.71		V

Functional Tests (In Innogration 1.6GHz narrow band Test Fixture, 50 ohm system) : V_{DD} = 28 Vdc, I_{DQ} = 80 mA, f = 1650 MHz, CW

Characteristic	Symbol	Min	Тур	Max	Unit
Power Gain	Gp		14.3		dB
Drain Efficiency @ P _{SAT}	Eff		71.3		%
Saturated Power	P _{SAT}		52.7		dBm
Input Return Loss	IRL		-7		dB
Mismatch stress at all phases (Device no damage)	VSWR		10:1		Ψ

Reference Circuit of Test Fixture Assembly Diagram

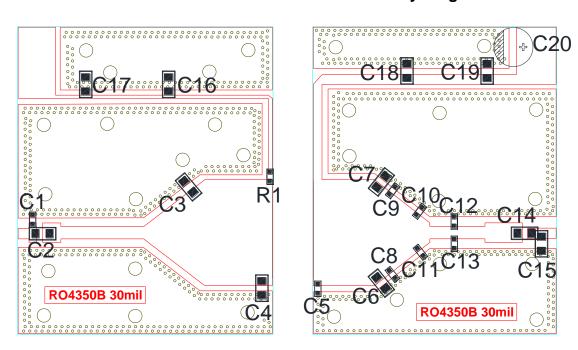


Figure 1. Test Circuit Component Layout (1500-1700MHz)

Table 4. Test Circuit Component Designations and Values (1500-1700MHz)

Component	Description	Suggested Manufacturer
C1,C10	0.5 pF	DLC70D0R5BW251NT
C2,C16,C18	33pF	DLC70B330JW501TX
C3	1.2pF	DLC70B1R2BW501TX
C4	2.2pF	DLC70B2R2BW501TX

C5,C13	0.8pF	DLC70D0R8BW251NT	
C6,C7	1pF	DLC70B1R0BW501TX	
C8,C9,C12	0.3pF	DLC70D0R3BW251NT	
C11	0.2 pF	DLC70D0R2BW251NT	
C14	12pF	DLC70B120JW501TX	
C15	0.5pF	DLC70B0R5BW501TX	
C17,C19	Ceramic multilayer capacitor,10uF/100V	10uF/100V	
C20	470uF	63V/470uF	
R1	16 Ω	0805	
PCB	30mil thick, εr=3.48, Rogers RO4350B, 1 oz. copper		

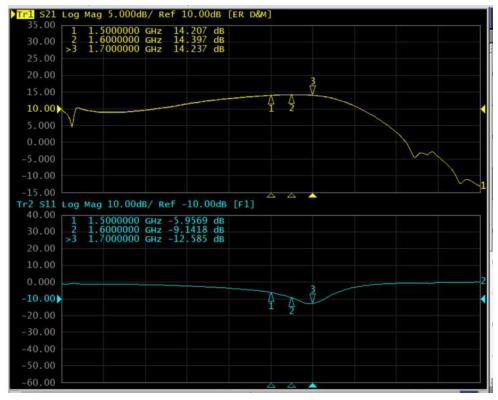


Figure 2. Network Analyzer S11/S21 output (Vds=28V,Vgs=-2.71V,Idq=100mA, Input Power =0dBm)

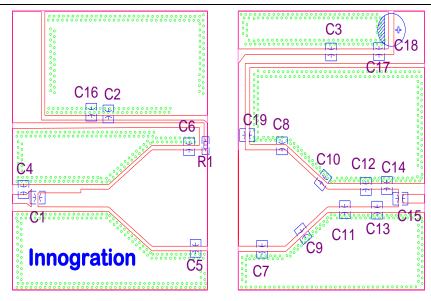


Figure 3. Test Circuit Component Layout (1100-1300MHz)

Table 5. Test Circuit Component Designations and Values(1100-1300MHz)

Part	description	Model	
C1,C2,C3	47pF	ATC800B	
C4,C7,C8,C9,C10	2.2pF	DLC70B	
C5,C6,C19	5.6pF	DLC70B	
C11,C12,C13,C14	1pF	DLC70B	
C15	33pF	DLC70B	
C16,C17	10UF	100V/10UF	
C18	2200UF	63V/2200UF	
R1	27Ω*2	0805	
PCB	30mil thick, εr=3.48, Rogers RO4350B, 1 oz. copper		

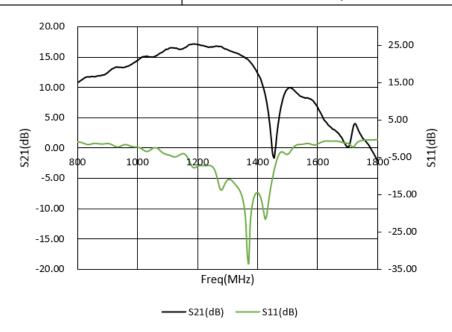


Figure 2. Network Analyzer S11/S21 output (Vds=28V,Vgs=-2.71V,Idq=100mA, Input Power =0dBm)

Package Outline

Flanged ceramic package; 2 leads

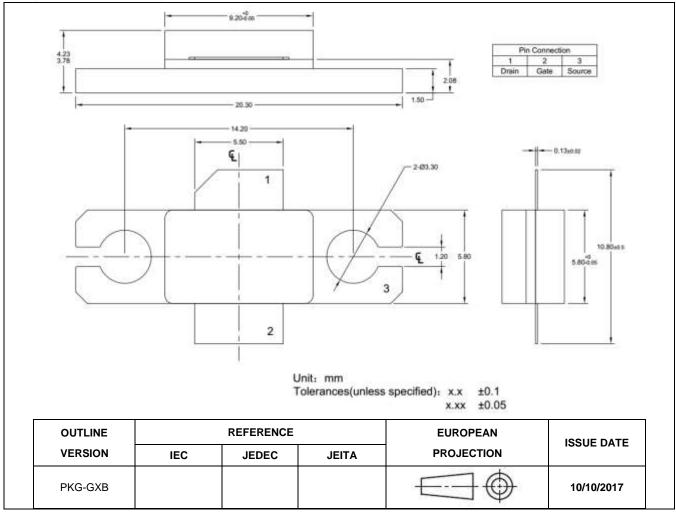


Figure 1. Package Outline PKG-G2E

Document Number: NU2515H Preliminary Datasheet V1.3

Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2019/12/27	V1.0	Preliminary Datasheet Creation
2020/2/17	V1.1	Correct typo of package info on first page
2020/9/14	V1.2	Modified application data based on the latest report
2025/4/7	V1.3	Add 1.3-1.95G broadband application data on 1st page

Application data based on ZL-20-15/GZY-20-37/TC-25-17

Notice

Specifications are subject to change without notice. Innogration believes the information within the data sheet to be reliable. Innogration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose.

"Typical" parameter is the average values expected by Innogration in quantities and are provided for information purposes only. It can and do vary in different applications and related performance can vary over time. All parameters should be validated by customer's technical experts for each application.

Innogration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility.

For any concerns or questions related to terms or conditions, please check with Innogration and authorized distributors Copyright © by Innogration (Suzhou) Co.,Ltd.